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INTEGRATED CIRCUITS, SILICON MONOLITHIC, CMOS

DECADE COUNTER/DIVIDER

WITH FULLY BUFFERED OUTPUTS

BASED ON TYPE 4017B

ESCC Detail Specification No. 9204/020

Issue 3	June 2006

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DOCUMENTATION CHANGE NOTICE

(Refer to https://escies.org for ESCC DCR content)

DCR No.	CHANGE DESCRIPTION
255	Specification up issued to incorporate editorial and technical changes per DCR.

TABLE OF CONTENTS

1. GENERAL

1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

(a) ESCC Generic Specification No. 9000
(b) MIL-STD-883, Test Methods and Procedures for Microelectronics

1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 The ESCC Component Number

The ESCC Component Number shall be constituted as follows:

Example: 920402001

- Detail Specification Reference: 9204020
- Component Type Variant Number: 01 (as required)

1.4.2 Component Type Variants

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Terminal Material and /or Finish	Weight max g
01	4017B	FP	G2	0.7
02	4017B	FP	G4	0.7
07	4017B	CCP	2	0.6
08	4017B	DIP	G2	2.2
09	4017B	DIP	G4	2.2
10	4017B	SO	G2	0.7
11	4017B	SO	G4	0.7

The terminal material and/or finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

1.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.

Characteristics	Symbols	Maximum Ratings	Units	Remarks
Supply Voltage	V_{DD}	-0.5 to 18	V	Note 1
Input Voltage	V_{IN}	-0.5 to V_{DD} +0.5	V	Note 1 Power on
Input Current	I_{IN}	±10	mA	-
Device Power Dissipation (Continuous)	P_D	200	mW	-
Power Dissipation per Output	P_{DSO}	100	mW	-
Operating Temperature Range	T_{op}	-55 to +125	^oC	T_{amb}
Storage Temperature Range	T_{stg}	-65 to +150	^oC	-
Soldering Temperature For FP, DIP and SO For CCP	T_{sol}	 +265 +245	^oC	 Note 2 Note 3

NOTES:

1. Device is functional for $3V \leq V_{DD} \leq 15V$.
2. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same terminal shall not be resoldered until 3 minutes have elapsed.
3. Duration 5 seconds maximum and the same terminal shall not be resoldered until 3 minutes have elapsed.

1.6 HANDLING PRECAUTIONS

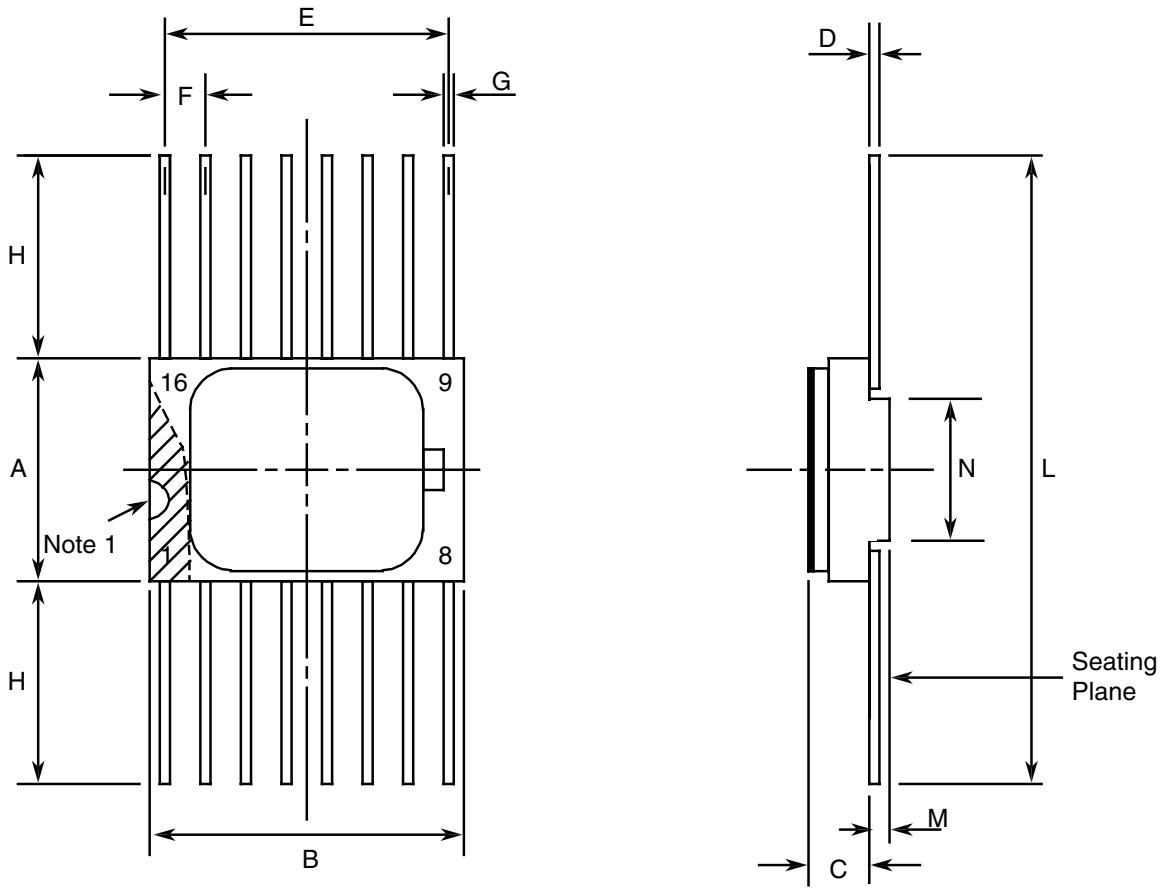
These devices are susceptible to damage by electrostatic discharge. Therefore, suitable precautions shall be employed for protection during all phases of manufacture, testing, packaging, shipment and any handling.

These components are categorised as Class 1 per ESCC Basic Specification No. 23800 with a minimum Critical Path Failure Voltage of 400 Volts.

1.7 PHYSICAL DIMENSIONS AND TERMINAL IDENTIFICATION

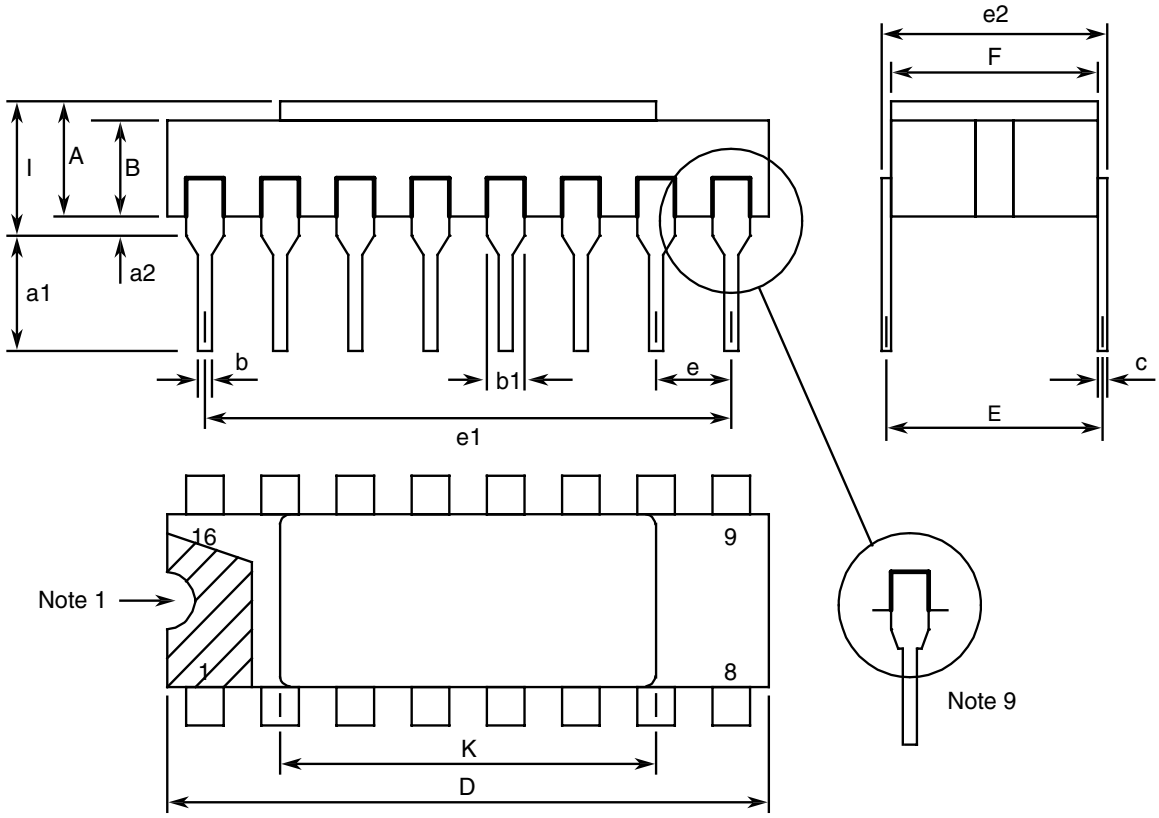
Consolidated Notes are given following the case drawings and dimensions.

1.7.1 Flat Package (FP) - 16 Pin



Symbols	Dimensions mm		Notes
	Min	Max	
A	6.75	7.06	
B	9.76	10.14	
C	1.49	1.95	
D	0.1	0.15	5
E	8.76	9.01	
F	1.27 BSC		3, 6
G	0.38	0.48	5
H	6	-	5
L	18.75	22	
M	0.33	0.43	
N	4.32 TYPICAL		

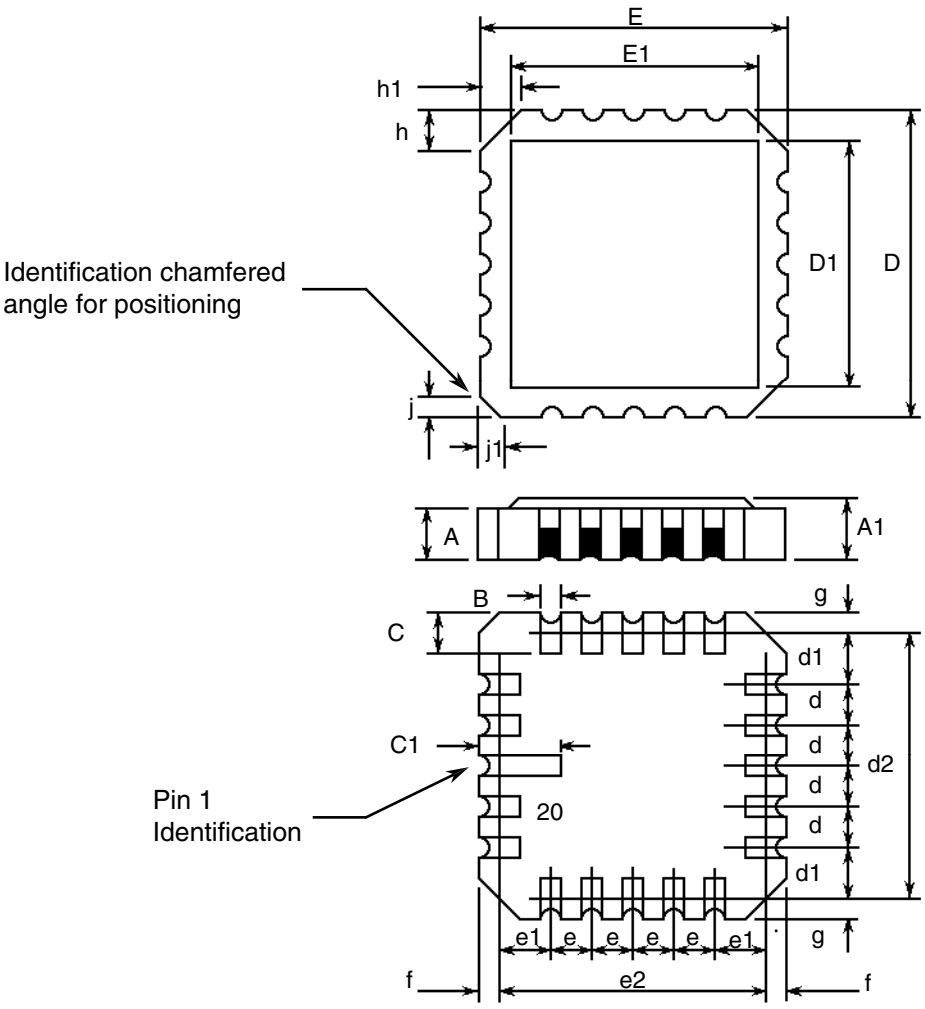
1.7.2 Dual-in-line Package (DIP) - 16 Pin



Symbols	Dimensions mm		Notes
	Min	Max	
A	2.1	2.71	
a1	3	3.7	
a2	0.63	1.14	2
B	1.82	2.39	
b	0.4	0.5	5
b1	1.14	1.5	5
c	0.2	0.3	5
D	20.06	20.58	
E	7.36	7.87	
e	2.54 BSC		4, 6
e1	17.65	17.9	
e2	7.62	8.12	
F	7.29	7.7	
I	-	3.83	

Symbols	Dimensions mm		Notes
	Min	Max	
K	10.9	12.1	

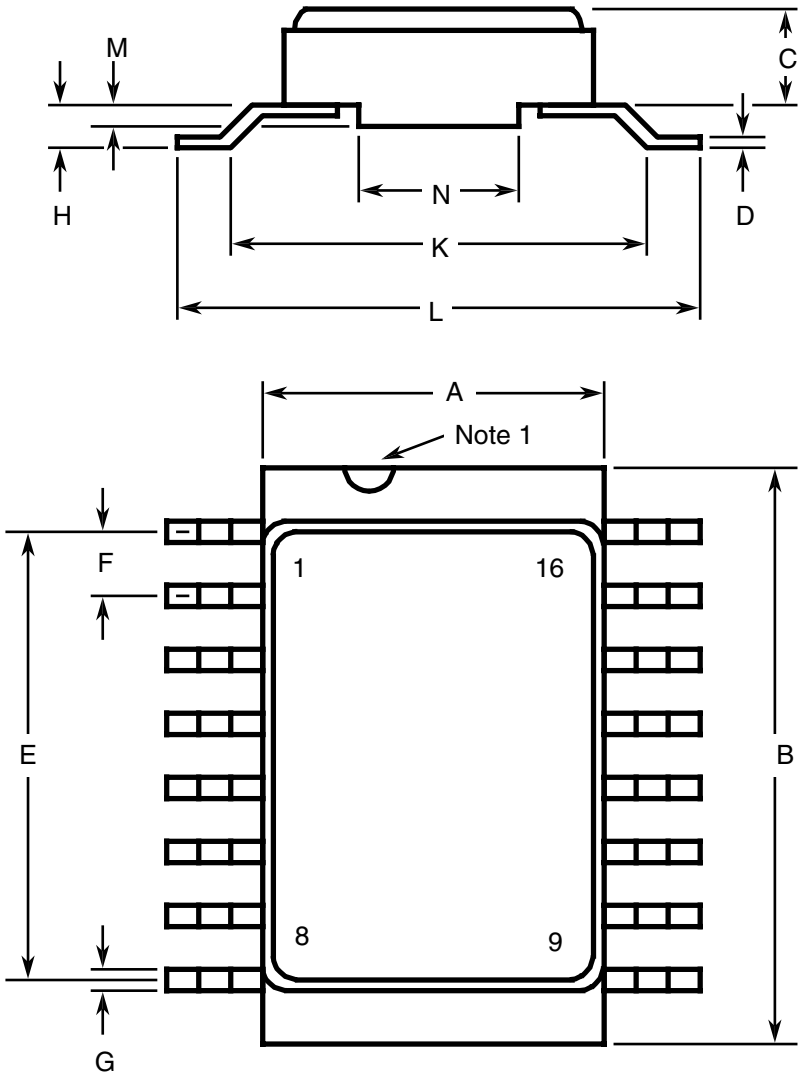
1.7.3 Chip Carrier Package (CCP) - 20 Terminal



Symbols	Dimensions mm		Notes
	Min	Max	
A	1.14	1.95	
A1	1.63	2.36	
B	0.55	0.72	5
C	1.06	1.47	5
C1	1.91	2.41	

Symbols	Dimensions mm		Notes
	Min	Max	
D	8.67	9.09	
D1	7.21	7.52	
d, d1	1.27 BSC		3
d2	7.62 BSC		
E	8.67	9.09	
E1	7.21	7.52	
e, e1	1.27 BSC		3
e2	7.62 BSC		
f, g	-	0.76	
h, h1	1.01 TYPICAL		8
j, j1	0.51 TYPICAL		7

1.7.4 Small Outline Ceramic Package (SO) - 16 Pin



Symbols	Dimensions mm		Notes
	Min	Max	
A	6.75	7.06	
B	9.76	10.14	
C	1.49	1.95	
D	0.1	0.15	5
E	8.76	9.01	
F	1.27 BSC		3, 6
G	0.38	0.48	5
H	0.6	0.9	5

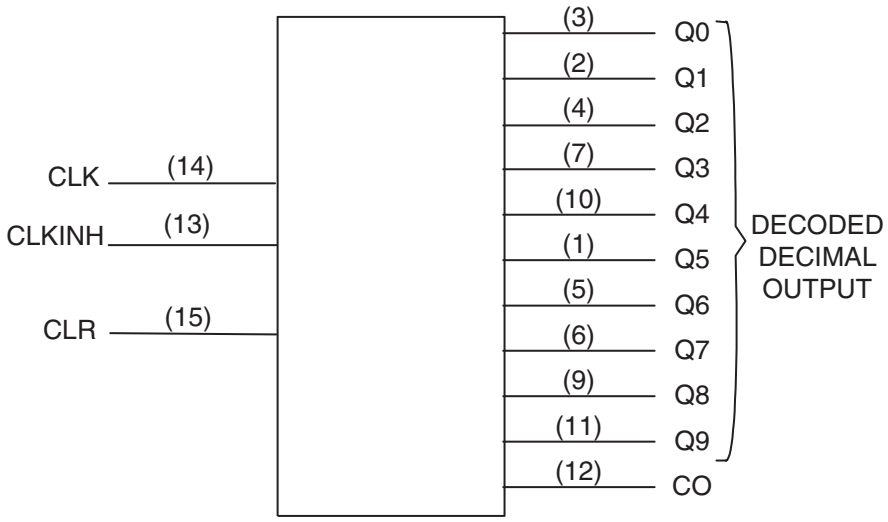
Symbols	Dimensions mm		Notes
	Min	Max	
K	9 TYPICAL		
L	10	10.65	
M	0.33	0.43	
N	4.31 TYPICAL		

1.7.5 Notes to Physical Dimensions and Terminal Identification

1. Index area; a notch or a dot shall be located adjacent to Pin 1 and shall be within the shaded area shown. For chip carrier packages, the index shall be as shown.
2. The dimension shall be measured from the seating plane to the base plane.
3. The true position pin spacing is 1.27mm between centrelines. Each pin centreline shall be located within ±0.13mm of its true longitudinal position relative to Pin 1 and the highest pin number.
4. The true position pin spacing is 2.54mm between centrelines. Each pin centreline shall be located within ±0.25mm of its true longitudinal position relative to Pin 1 and the highest pin number.
5. All terminals.
6. 14 spaces for flat, dual-in-line and small outline packages.
7. Index corner only - 2 dimensions.
8. 3 non-index corners - 6 dimensions.
9. For all pins, either pin shape may be supplied.

1.8 FUNCTIONAL DIAGRAM

Pin numbers relate to FP, DIP and SO packages only



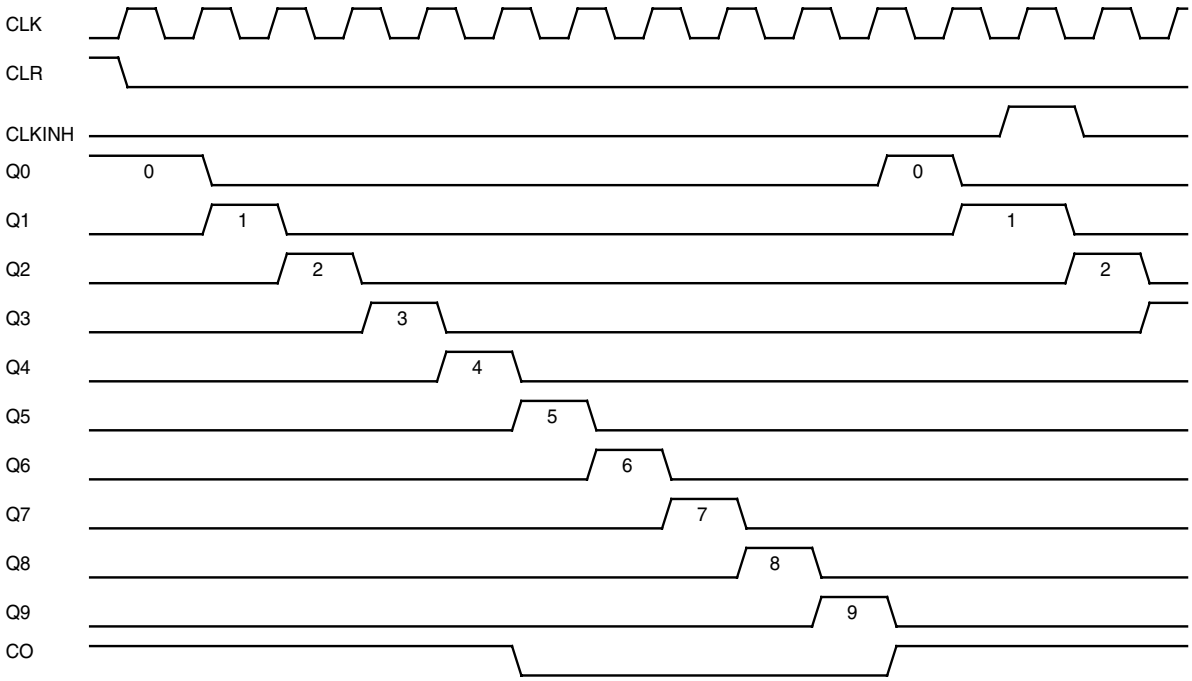
1.9 PIN ASSIGNMENT

Pin	Function		Pin	Function	
	FP, DIP and SO	CCP		FP, DIP and SO	CCP
1	Q5 Output	Q5 Output	11	Q9 Output	Q8 Output
2	Q1 Output	Q1 Output	12	CO Output (Carry Out)	Q4 Output
3	Q0 Output	-	13	CLKINH Input (Clock Inhibit)	-
4	Q2 Output	Q0 Output	14	CLK Input (Clock)	Q9 Output
5	Q6 Output	Q2 Output	15	CLR Input (Clear)	CO Output (Carry Out)
6	Q7 Output	Q6 Output	16	V_{DD}	CLKINH Input (Clock Inhibit)
7	Q3 Output	Q7 Output	17	-	CLK Input (Clock)
8	V_{SS}	-	18	-	-
9	Q8 Output	Q3 Output	19	-	CLR Input (Clear)
10	Q4 Output	V_{SS}	20	-	V_{DD}

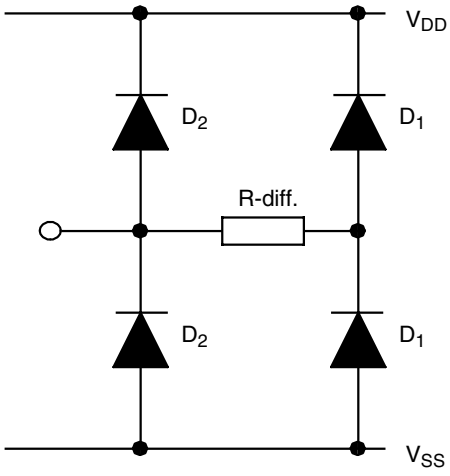
1.10 TRUTH TABLE AND TIMING CHART

1. Logic Level Definitions: L = Low Level, H = High Level, X = Irrelevant.
2. ↑ = Transition, Low to High, ↓ = Transition, High to Low.

INPUTS			OUTPUTS
CLR	CLK	CLKINH	
H	X	X	CLEAR (Q0 = H ; Q1 to Q9 = L)
L	↑	L	COUNTER ADVANCES
L	H	↓	COUNTER ADVANCES
L	L	X	NO CHANGE
L	X	H	NO CHANGE
L	H	↑	NO CHANGE
L	↓	L	NO CHANGE



1.11 INPUT PROTECTION NETWORK



2. REQUIREMENTS

2.1 GENERAL

The complete requirements for procurement of the components specified herein are as stated in this specification and the ESCC Generic Specification. Permitted deviations from the Generic Specification, applicable to this specification only, are listed below.

Permitted deviations from the Generic Specification and this Detail Specification, formally agreed with

specific Manufacturers on the basis that the alternative requirements are equivalent to the ESCC requirement and do not affect the component's reliability, are listed in the appendices attached to this specification.

2.1.1 Deviations from the Generic Specification

None.

2.2 MARKING

The marking shall be in accordance with the requirements of ESCC Basic Specification No. 21700 and as follows.

The information to be marked on the component shall be:

(a) Terminal identification.
(b) The ESCC qualified components symbol (for ESCC qualified components only).
(c) The ESCC Component Number.
(d) Traceability information.

2.3 ELECTRICAL MEASUREMENTS AT ROOM, HIGH AND LOW TEMPERATURES

Electrical measurements shall be performed at room, high and low temperatures. Consolidated Notes are given after the tables.

2.3.1 Room Temperature Electrical Measurements

The measurements shall be performed at T_{amb}=+22 ±3°C.

Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Functional Test 1	-	3014	Verify Truth Table without Load V_{IL}=0V,V_{IH}=3V V_{DD}=3V,V_{SS}=0V Note 2	-	-	-
Functional Test 2	-	3014	Verify Truth Table without Load V_{IL}=0V,V_{IH}=15V V_{DD}=15V,V_{SS}=0V Note 2	-	-	-
Quiescent Current	I_{DD}	3005	V_{IL}=0V,V_{IH}=15V V_{DD}=15V,V_{SS}=0V Note 3	-	1	µA
Low Level Input Current	I_{IL}	3009	V_{IN} (Under Test)=0V V_{DD}=15V,V_{SS}=0V	-	-50	nA
High Level Input Current	I_{IH}	3010	V_{IN} (Under Test)=15V V_{DD}=15V,V_{SS}=0V	-	50	nA

Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Low Level Output Voltage 1	V_{OL1}	3007	V_{IL}=0V, V_{IH}=15V, I_{OL}=0A V_{DD}=15V, V_{SS}=0V	-	50	mV
Low Level Output Voltage 2 (Noise Immunity)	V_{OL2}	3007	V_{IL}=1.5V, V_{IH}=3.5V, I_{OL}=0A V_{DD}=5V, V_{SS}=0V	-	500	mV
Low Level Output Voltage 3 (Noise Immunity)	V_{OL3}	3007	V_{IL}=4V, V_{IH}=11V, I_{OL}=0A V_{DD}=15V, V_{SS}=0V	-	1.5	V
High Level Output Voltage 1	V_{OH1}	3006	V_{IL}=0V, V_{IH}=15V, I_{OH}=0A V_{DD}=15V, V_{SS}=0V	14.95	-	V
High Level Output Voltage 2 (Noise Immunity)	V_{OH2}	3006	V_{IL}=1.5V, V_{IH}=3.5V, I_{OH}=0A V_{DD}=5V, V_{SS}=0V	4.5	-	V
High Level Output Voltage 3 (Noise Immunity)	V_{OH3}	3006	V_{IL}=4V, V_{IH}=11V, I_{OH}=0A V_{DD}=15V, V_{SS}=0V	13.5	-	V
Low Level Output Current 1	I_{OL1}	-	V_{IL}=0V, V_{IH}=5V, V_{OL}=0.4V V_{DD}=5V, V_{SS}=0V Note 4	510	-	µA
Low Level Output Current 2	I_{OL2}	-	V_{IL}=0V, V_{IH}=15V, V_{OL}=1.5V V_{DD}=15V, V_{SS}=0V Note 4	3.4	-	mA
High Level Output Current 1	I_{OH1}	-	V_{IL}=0V, V_{IH}=5V, V_{OH}=4.6V V_{DD}=5V, V_{SS}=0V Note 4	-510	-	µA
High Level Output Current 2	I_{OH2}	-	V_{IL}=0V, V_{IH}=15V, V_{OH}=13.5V V_{DD}=15V, V_{SS}=0V Note 4	-3.4	-	mA
Threshold Voltage N-Channel	V_{THN}	-	CLR Input at Ground All Other Inputs: V_{IN}=5V V_{DD}=5V, I_{SS}=-10µA	-0.7	-3	V
Threshold Voltage P-Channel	V_{THP}	-	CLR Input at Ground All Other Inputs: V_{IN}=-5V V_{SS}=-5V, I_{DD}=10µA	0.7	3	V
Input Clamp Voltage 1, to V_{SS}	V_{IC1}	-	I_{IN} (Under Test)= -100µA V_{DD}=Open, V_{SS}=0V All Other Pins Open	-	-2	V

Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Input Clamp Voltage 2, to V_{DD}	V_{IC2}	-	V_{IN} (Under Test)=6V R=30kΩ, V_{SS}=Open All Other Pins Open Note 5	3	-	V
Input Capacitance	C_{IN}	3012	V_{IN} (Not Under Test)=0V V_{DD}= V_{SS}=0V f = 100 kHz to 1 MHz Note 6	-	7.5	pF
Propagation Delay Low to High, CLK to Q1	t_{PLH1}	3003	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	750	ns
Propagation Delay Low to High, CLK to CO	t_{PLH2}	3003	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	600	ns
Propagation Delay Low to High, CLR to Q0	t_{PLH3}	3003	V_{IN}(Under Test)=Pulse Generator CLR Connected to V_{DD} V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	750	ns
Propagation Delay Low to High, CLR to CO	t_{PLH4}	3003	V_{IN}(Under Test)=Pulse Generator CLR Connected to V_{DD} V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	600	ns
Propagation Delay High to Low, CLK to Q1	t_{PHL1}	3003	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	750	ns

Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Propagation Delay High to Low, CLK to CO	t_{PHL2}	3003	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	600	ns
Propagation Delay High to Low, CLR to Q2	t_{PHL3}	3003	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	750	ns
Transition Time Low to High, Q1	t_{TLH}	3004	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	150	ns
Transition Time High to Low, Q1	t_{THL}	3004	V_{IN}(Under Test)=Pulse Generator V_{IN} (Remaining Inputs)=Truth Table V_{IL}=0V, V_{IH}=5V, V_{DD}=5V, V_{SS}=0V Note 7	-	150	ns
Maximum Clock Frequency	f_{CLK}	-	V_{IN}(CLK)=Pulse Generator V_{IN} (Remaining Inputs)=V_{SS} V_{IL}=0V, V_{IH}=5V V_{DD}=5V, V_{SS}=0V Note 8, 9	2.5	-	MHz

2.3.2 High and Low Temperatures Electrical Measurements

The measurements shall be performed at T_{amb}=+125 (+0 -5) ^{o}C and T_{amb}=- 55(+5-0)^{o}C.

Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Functional Test 1	-	3014	Verify Truth Table without Load V_{IL}=0V,V_{IH}=3V V_{DD}=3V,V_{SS}=0V Note 2	-	-	-

Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Functional Test 2	-	3014	Verify Truth Table without Load V_{IL}=0V,V_{IH}=15V V_{DD}=15V,V_{SS}=0V Note 2	-	-	-
Quiescent Current	I_{DD}	3005	V_{IL}=0V,V_{IH}=15V V_{DD}=15V,V_{SS}=0V Note 3 T_{amb}=+125°C T_{amb}=- 55°C	 - -	 30 1	µA
Low Level Input Current	I_{IL}	3009	V_{IN} (Under Test)=0V V_{DD}=15V,V_{SS}=0V T_{amb}=+125°C T_{amb}=- 55°C	 - -	 -100 -50	nA
High Level Input Current	I_{IH}	3010	V_{IN} (Under Test)=15V V_{DD}=15V,V_{SS}=0V T_{amb}=+125°C T_{amb}=- 55°C	 - -	 100 50	nA
Low Level Output Voltage 1	V_{OL1}	3007	V_{IL}=0V, V_{IH}=15V, I_{OL}=0A V_{DD}=15V, V_{SS}=0V	-	50	mV
Low Level Output Voltage 2 (Noise Immunity)	V_{OL2}	3007	V_{IL}=1.5V, V_{IH}=3.5V, I_{OL}=0A V_{DD}=5V, V_{SS}=0V	-	500	mV
Low Level Output Voltage 3 (Noise Immunity)	V_{OL3}	3007	V_{IL}=4V, V_{IH}=11V, I_{OL}=0A V_{DD}=15V, V_{SS}=0V	-	1.5	V
High Level Output Voltage 1	V_{OH1}	3006	V_{IL}=0V, V_{IH}=15V, I_{OH}=0A V_{DD}=15V, V_{SS}=0V	14.95	-	V
High Level Output Voltage 2 (Noise Immunity)	V_{OH2}	3006	V_{IL}=1.5V, V_{IH}=3.5V, I_{OH}=0A V_{DD}=5V, V_{SS}=0V	4.5	-	V
High Level Output Voltage 3 (Noise Immunity)	V_{OH3}	3006	V_{IL}=4V, V_{IH}=11V, I_{OH}=0A V_{DD}=15V, V_{SS}=0V	13.5	-	V
Low Level Output Current 1	I_{OL1}	-	V_{IL}=0V, V_{IH}=5V, V_{OL}=0.4V V_{DD}=5V, V_{SS}=0V Note 4 T_{amb}=+125°C T_{amb}=- 55°C	 360 640	 - -	µA

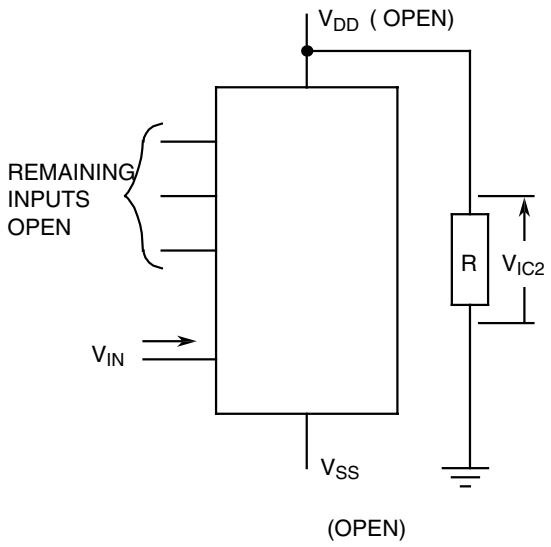
Characteristics	Symbols	MIL-STD-883 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Low Level Output Current 2	I_{OL2}	-	V_{IL}=0V, V_{IH}=15V, V_{OL}=1.5V V_{DD}=15V, V_{SS}=0V Note 4			mA
			T_{amb}=+125°C	2.4	-	
			T_{amb}=- 55°C	4.2	-	
High Level Output Current 1	I_{OH1}	-	V_{IL}=0V, V_{IH}=5V, V_{OH}=4.6V V_{DD}=5V, V_{SS}=0V Note 4			µA
			T_{amb}=+125°C	-360	-	
			T_{amb}=- 55°C	-640	-	
High Level Output Current 2	I_{OH2}	-	V_{IL}=0V, V_{IH}=15V, V_{OH}=13.5V V_{DD}=15V, V_{SS}=0V Note 4			mA
			T_{amb}=+125°C	-2.4	-	
			T_{amb}=- 55°C	-4.2	-	
Threshold Voltage N-Channel	V_{THN}	-	CLR Input at Ground All Other Inputs: V_{IN}=5V V_{DD}=5V, I_{SS}=-10µA			V
			T_{amb}=+125°C	-0.3	-3.5	
			T_{amb}=- 55°C	-0.7	-3.5	
Threshold Voltage P-Channel	V_{THP}	-	CLR Input at Ground All Other Inputs: V_{IN}=-5V V_{SS}=-5V, I_{DD}=10µA			V
			T_{amb}=+125°C	0.3	3.5	
			T_{amb}=- 55°C	0.7	3.5	

2.3.3 Notes to Electrical Measurement Tables

1. Unless otherwise specified all inputs and outputs shall be tested for each characteristic, inputs not under test shall be V_{IN} = V_{SS} or V_{DD} and outputs not under test shall be open.
2. Functional tests shall be performed to verify Truth Table with $V_{OH} \geq V_{DD}$ -0.5V, $V_{OL} \leq$ 0.5V. The Maximum time to output comparator strobe = 300µs.
3. Quiescent Current shall be tested using the following input conditions where 1 = V_{IH} and 0 = V_{IL}:

I_{DD} Test	Input Pattern No.	Input Conditions		
		CLKINH	CLK	CLR
(a)	1	0	0	1
(b)	2	1	1	1
	3	1	1	0
(c)	4	0	1	0
	5	1	1	0
(d)	6	0	1	0
	7	1	1	0
	8	0	1	0
(e)	9	1	1	0
	10	0	1	0
(f)	11	1	1	0
	12	0	1	0
(g)	13	0	0	0
(h)	14	0	1	0
	15	0	0	0
(i)	16	0	1	0
	17	0	0	0
(j)	18	0	1	0
	19	0	0	0
(k)	20	0	1	0

4. Interchange of forcing and measuring parameters is permitted.
5. Input Clamp Voltage 2 to V_{DD}, V_{IC2}, shall be tested on each input as follows:-



6. Guaranteed but not tested.
7. Read and record measurements shall be performed on a sample of 32 components with 0 failures permitted.
   The pulse generator shall have the following characteristics:

   V_{GEN} = 0 to V_{DD}; f = 500kHz; tr and t_f ≤15 ns (10% to 90%); duty cycle = 50%. Output load capacitance C_L = 50pF ±5% including scope probe, wiring and stray capacitance without component in the test fixture. Output load resistance R_L = 200kΩ.

   Propagation delay shall be measured referenced to the 50% input and output voltages.

   Transition time shall be measured referenced to the 10% and 90% output voltage.

8. Read and record measurements shall be performed on a sample of 32 components with 0 failures permitted.
9. A pulse, having the following conditions, shall be applied to the CLK input: V_P=0V to V_{DD}. Maximum clock frequency f_{CLK} requirement shall be considered as met if proper output state changes occur with the pulse repetition rate set to that given in the Limits column.

2.4 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at T_{amb}=+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits			Units
		Drift Value Δ	Absolute		
			Min	Max	
Quiescent Current	I_{DD}	±0.15	-	1	µA
Low Level Output Current 1	I_{OL1}	±15% (2)	510	-	µA
High Level Output Current 1	I_{OH1}	±15% (2)	-510	-	µA
Threshold Voltage N-Channel	V_{THN}	±0.3	-0.7	-3	V
Threshold Voltage P-Channel	V_{THP}	±0.3	0.7	3	V

NOTES:
1. Unless otherwise specified all inputs and outputs shall be tested for each characteristic.
2. Percentage of limit value if voltage is the measuring parameter.

2.5 INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS

Unless otherwise specified, the measurements shall be performed at T_{amb}=+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements .

The drift values (Δ) shall not be exceeded for each characteristic where specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits			Units
		Drift Value Δ	Absolute		
			Min	Max	
Functional Test 1	-	-	-	-	-
Quiescent Current	I_{DD}	± 0.15	-	1	µA
Low Level Input Current	I_{IL}	-	-	-50	nA
High Level Input Current	I_{IH}	-	-	50	nA
Low Level Output Voltage 1	V_{OL1}	-	-	50	mV
Low Level Output Voltage 2 (Noise Immunity)	V_{OL2}	-	-	500	mV
High Level Output Voltage 1	V_{OH1}	-	14.95	-	V
High Level Output Voltage 2 (Noise Immunity)	V_{OH2}	-	4.5	-	V
Low Level Output Current 1	I_{OL1}	±15% (3)	510	-	µA
Low Level Output Current 2	I_{OL2}	±15% (3)	3.4	-	mA
High Level Output Current 1	I_{OH1}	±15% (3)	-510	-	µA
High Level Output Current 2	I_{OH2}	±15% (3)	-3.4	-	mA
Threshold Voltage N-Channel	V_{THN}	±0.3	-0.7	-3	V
Threshold Voltage P-Channel	V_{THP}	±0.3	0.7	3	V

NOTES:

1. Unless otherwise specified all inputs and outputs shall be tested for each characteristic.
2. The drift values (Δ) are applicable to the Operating Life test only.
3. Percentage of limit value if voltage is the measuring parameter.

2.6 HIGH TEMPERATURE REVERSE BIAS BURN-IN CONDITIONS

2.6.1 N-Channel HTRB

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T_{amb}	+125 (+0 -5)	^{o}C
Outputs Q, CO	V_{OUT}	Open	V
Input CLR	V_{IN}	V_{DD}	V
Inputs CLK, CLKINH	V_{IN}	V_{SS}	V
Positive Supply Voltage	V_{DD}	15 (+0 -0.5)	V
Negative Supply Voltage	V_{SS}	0	V
Duration	t	72	Hours

NOTES:
1. Input Protection Resistor = 2kΩ min to 47kΩ max.

2.6.2 P-Channel HTRB

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T_{amb}	+125 (+0 -5)	^{o}C
Outputs Q, CO	V_{OUT}	Open	V
Input CLR	V_{IN}	V_{SS}	V
Inputs CLK, CLKINH	V_{IN}	V_{DD}	V
Positive Supply Voltage	V_{DD}	15 (+0 -0.5)	V
Negative Supply Voltage	V_{SS}	0	V
Duration	t	72	Hours

NOTES:
1. Input Protection Resistor = 2kΩ min to 47kΩ max.

2.7 POWER BURN-IN CONDITIONS

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T_{amb}	+125 (+0 -5)	^{o}C
Outputs Q, CO	V_{OUT}	$V_{DD}/2$	V
Inputs CLR, CLKINH	V_{IN}	V_{SS}	V
Input CLK	V_{IN}	V_{GEN}	V
Pulse Voltage	V_{GEN}	0V to V_{DD}	V
Pulse Frequency Square Wave	f_{GEN}	$50k \leq f \leq 1M$ 50% Duty Cycle	Hz
Positive Supply Voltage	V_{DD}	15 (+0 -0.5)	V
Negative Supply Voltage	V_{SS}	0	V

NOTES:

1. Input Protection Resistor = Output Load = 2kΩ min to 47kΩ max.

2.8 OPERATING LIFE CONDITIONS

The conditions shall be as specified for Power Burn-in.

APPENDIX 'A'

AGREED DEVIATIONS FOR STMICROELECTRONICS (F)

ITEMS AFFECTED	DESCRIPTION OF DEVIATIONS
Deviations from Screening Tests - Chart F3	External Visual Inspection: The criteria applicable to chip-outs are those described in MIL-STD-883, Test Method 2009, Paras 3.3.6(b) and 3.3.7(a). High Temperature Reverse Bias Burn-in: The temperature limits of MIL-STD-883, Para. 4.5.8(c) may be used. Power Burn-in test is performed using STMicroelectronics Specification Ref: 0019255.
Deviations from Qualification and Periodic Tests - Chart F4	External Visual Inspection: The criteria applicable to chip-outs are those described in MIL-STD-883, Test Method 2009, Paras 3.3.6(b) and 3.3.7(a). Operating Life: The temperature limits of MIL-STD-883, Para. 4.5.8(c) may be used.
Deviations from High and Low Temperatures Electrical Measurements	High and Low Temperatures Electrical Measurements may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes High and Low Temperatures Electrical Measurements per the Detail Specification. A summary of the pilot lot testing shall be provided if required by the Purchase Order.
Deviations from Room Temperature Electrical Measurements	All AC characteristics (Capacitance and Timings) may be considered guaranteed but not tested if successful pilot lot testing has been performed on the wafer lot which includes AC characteristic measurements per the Detail Specification. A summary of the pilot lot testing shall be provided if required by the Purchase Order.